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In re the Application of  
Bowles, et al.

TI-24521

Serial No.: 09/732,468

Art Unit: 1765

Filed: December 7, 2000

Examiner: V. Perez-Ramos

Title: Method for Unpatterned Resist Etch Back of Shallow  
Trench Isolation Refill Insulator

August 30, 2002

Assistant Commissioner for  
Patents  
Washington, D.C. 20231

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*Jackie McBride*  
Jackie McBride

Dear Sir:

Transmitted herewith is an amendment in this application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	19	Minus	21	= 0	x \$18 =	\$ 0
Ind. Claims	02	Minus	03	= 0	x \$84 =	\$ 0
TOTAL ADDITIONAL FEE FOR THIS AMOUNT						\$ 0

Under 37 C.F.R. § 1.16(k) please charge the total additional fee,  
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Respectfully submitted,

*Yingsheng Tung*

Texas Instruments Incorporated  
P.O. Box 655474, M/S 3999  
Dallas, Texas 75265  
(972) 917-5355

Yingsheng Tung  
Reg. No. 52,305  
Attorney for Applicants

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Amendment-A Under 37 CFR 1.116

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Washington D.C. 20231 on: 08/30/2002.

*Jackie McBride*  
Jackie McBride

Dear Sir:

Responsive to Examiner's Office Action dated July 23,  
2002, Applicants amend this application as follows:

In the Claims:

Cancel claims 12 and 21; amend claims 1, 2, 13, 14,  
and 15 as follows:

1. A method for forming shallow trench isolation  
structures, comprising:

forming a plurality of isolation trenches in a  
substrate, the isolation trenches separating active areas;

B1